



ADJUSTABLE PRECISION SHUNT REGULATORS

DESCRIPTION

The μ PC1943,1944 are adjustable precision shunt regulators with guaranteed thermal stability. The output voltage can be set to any value between reference voltage (1.26 V) and 24 V by two external resistors.

These ICs can apply to error amplifier of switching regulators.

FEATURES

• Low voltage operation and High accuracy.

 $V_{\text{REF}} = 1.26 \text{ V} \pm 2.4 \text{ \%}$ $V_{\text{REF}} \leq V_{\text{OUT}} \leq 24 \text{ V}$

- Adjustable output voltage by two external resistors.
- Pin compatible to μ PC1093.

ORDERING INFORMATION

	Part Number	Package
*	μPC1943T	Power mini mold (SOT-89)
*	μ PC1944T	Power mini mold (SOT-89)
	μ PC1944J	3-pin plastic SIP (TO-92)
	μ PC1944GR	8-pin plastic SOP (5.72 mm (225))





PIN CONFIGURATION (Marking Side)



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Paramete	er	Symbol	Ratings	Unit
Cathode Voltage		Vка	25	V
Cathode Current		lκ	50	mA
Cathode to Anode Reverse Current		— І к	-30	mA
Reference Voltage		Vref	7	V
Reference Input Current		IREF	50	μA
Reference to Anode Reverse Current		- Ref	- 10	mA
Total Power Dissipation	μPC1943T	P⊤	320 (1600 ^{Note})	mW
	μPC1944T		320 (1600 ^{Note})	mW
	μPC1944J		560	mW
	μPC1944GR		385	mW
Operating Ambient Temperature		TA	- 30 to + 85	°C
Operating Junction Temperature		TJ	- 30 to + 125	°C
Storage Temperature		Tstg	- 65 to + 125	°C

ABSOLUTE MAXIMUM RATINGS (TA = +25 °C, unless otherwise specified.)

Note with 16 cm² \times 0.7 mm ceramic substrate.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

TYPICAL CONNECTION



Data Sheet G10239EJ3V0DS00

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RECOMMENDED OPERATING CONDITIONS

Parame	ter	Symbol	MIN.	TYP.	MAX.	Unit
Cathode Voltage		Vka	Vref		24	V
Cathode Current		lк	1	10	30	mA
Total Power Dissipation	μPC1943T	Рт			45 (240 ^{Note})	mW
	μPC1944T				45 (240 ^{Note})	mW
	μPC1944J	1			83	mW
	μPC1944GR				57	mW
Operating Ambient Temperature		TA	-30		+85	°C
Operating Junction Temperature		TJ	-30		+100	°C

Note with 16 cm² \times 0.7 mm ceramic substrate.

Caution The recommended operating range may be exceeded without causing any problems provided that the absolute maximum ratings are not exceeded. However, if the device is operated in a way that exceeds the recommended operating conditions, the margin between the actual conditions of use and the absolute maximum ratings is small, and therefore thorough evaluation is necessary. The recommended operating conditions do not imply that the device can be used with all values at their maximum values.

ELECTRICAL CHARACTERISTICS (IK = 10 mA, TA = +25 °C, unless otherwise specified.)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Reference Voltage	Vref	Vka = Vref	1.23	1.26	1.29	V
Reference Voltage Deviation Over Temperature	ΔV_{REF}	$V_{\text{KA}} = V_{\text{REF}}, \ 0 \ ^{\circ}\text{C} \leq T_{\text{A}} \leq 70 \ ^{\circ}\text{C}$		±5	± 30	mV
Reference Voltage Deviation	$\Delta V_{\text{REF}} \Delta V_{\text{KA}}$	$ V_{REF} \le V_{KA} \le 5V$			2.7	mV/V
Over Cathode Voltage		$5 \text{ V} \leq V_{\text{KA}} \leq 24 \text{ V}$			2.0	mV/V
Reference Input Current	IREF	$V_{KA} = V_{REF}, R_1 = 10 \text{ k}\Omega, R2 = \infty$		2.0	4.0	μA
Reference Input Current Deviation Over Temperature	arDelta Iref	$\label{eq:KA} \begin{split} V_{KA} &= V_{REF}, \ 0 \ ^\circ C \leq T_{A} \leq 70 \ ^\circ C, \\ R_1 &= 10 \ k\Omega, \ R2 = \infty \end{split}$		0.3	1.2	μA
Minimum Cathode Current	IKmin	$V_{KA} = V_{REF}, \Delta V_{REF} = 2\%$		0.16	1.0	mA
Off-state Cathode Current	IKoff	Vka = 24 V, Vref = 0 V		0.01	1.0	μA
Dynamic Impedance	Zka	$V_{KA} = V_{REF}, f \le 1 \text{ kHz},$ 1 mA \le Ik \le 30 mA		0.12	0.5	Ω



TYPICAL CHARACTERISTIC (TA = +25 °C, unless otherwise specified. Nominal)



CKA: Monolithic Ceramic Capacitor

★ Caution of Stability Area

If the Aluminum electrolytic capacitor is used, it should be kept $C_{KA} \ge 6.8 \ \mu$ F. When using plural different types of capacitors, each capacitor is needed to be stable independently.

PACKAGE DRAWINGS

* POWER MINI MOLD (SOT-89) (Unit: mm)



8-PIN PLASTIC SOP (5.72 mm (225))



NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
А	$5.2 \begin{array}{c} +0.17 \\ -0.20 \end{array}$
В	0.78 MAX.
С	1.27 (T.P.)
D	$0.42\substack{+0.08\\-0.07}$
E	0.1±0.1
F	1.59±0.21
G	1.49
Н	6.5±0.3
I	4.4±0.15
J	1.1±0.2
к	$0.17\substack{+0.08\\-0.07}$
L	0.6±0.2
М	0.12
Ν	0.10
Р	$3^{\circ}^{+7^{\circ}}_{-3^{\circ}}$
	S8GM-50-225B-6

3-PIN PLASTIC SIP (TO-92)



NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	5.0±0.2
F	$0.50\substack{+0.30 \\ -0.10}$
G	0.12
Н	1.27
J	1.33 MAX.
М	5.0±0.5
Ν	4.0±0.2
U	2.8 MAX.
V	0.50±0.10
Y	15.0±0.7
	P3J-127B-3

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RECOMMENDED SOLDERING CONDITIONS

When soldering these products, there are highly recommended to observe the conditions as shown below.

If other soldering processes are used, or if the soldering is performed under different conditions, please make sure to consult with our sales offices.

For more details, refer to our document "Semiconductor Device Mounting Technology Manual" (C10535E).

Type of Surface Mount Device

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μ PC1943T, 1944T : Power mini mold (SOT-89)

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235 °C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210 °C or higher), Maximum number of reflow processes: 2 times.	IR35-00-2
VPS	Peak temperature: 215 °C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200 °C or higher), Maximum number of reflow processes: 2 times.	VP15-00-2
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120 °C or below (Package surface temperature).	WS60-00-1

Caution Apply only one kind of soldering condition to a device, or the device will be damaged by heat stress.

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235 °C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210 °C or higher), Maximum number of reflow processes: 1 time.	IR35-00-1
VPS	Peak temperature: 215 °C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200 °C or higher), Maximum number of reflow processes: 1 time.	VP15-00-1
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120 °C or below (Package surface temperature).	WS60-00-1

μ PC1944GR : 8-pin plastic SOP (5.72 mm (225))

Caution Apply only one kind of soldering condition to a device, or the device will be damaged by heat stress.

Type of Through-hole Device

μPC1944J : 3-pin plastic SIP (TO-92)

Process	Conditions
Wave soldering (only to leads)	Solder temperature: 260 °C or below, Flow time: 10 seconds or less.

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

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* REMARK OF THE PACKAGE MARK

The package marks of the μ PC1943T and the μ PC1944T are the symbols as follows.

Part Number	Mark
μPC1943T	9B
μPC1944T	9C

REFERENCE DOCUMENTS

Semiconductor Device Mounting Technology ManualC10535ESemiconductor Selection Guide -Products and Packages-X13769X

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- NEC devices are classified into the following three quality grades:
 "Standard", "Special", and "Specific". The Specific quality grade applies only to devices developed based on a
 customer designated "quality assurance program" for a specific application. The recommended applications of
 a device depend on its quality grade, as indicated below. Customers must check the quality grade of each device
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 - Special: Transportation equipment (automobiles, trains, ships, etc.), traffic control systems, anti-disaster systems, anti-crime systems, safety equipment and medical equipment (not specifically designed for life support)
 - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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